

DIGITAL CONTROLLED AUDIO PROCESSOR

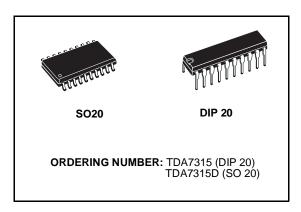
- 1 STEREO INPUT
- LOUDNESS FUNCTION
- VOLUME CONTROL IN 1.25dB STEPS
- TREBLE AND BASS CONTROL
- TWO SPEAKERS ATTENUATORS:
 - INDEPENDENT SPEAKERS CONTROL IN 1.25dB STEPS
 - INDEPENDENT MUTE FUNCTION
- ALL FUNCTIONS PROGRAMMABLE VIA SE-RIAL BUS

DESCRIPTION

The TDA7315 is a volume, tone (bass and treble) balance (Left/Right) processor for quality audio applications in car radio and Hi-Fi systems.

Control is accomplished by serial bus microprocessor interface.

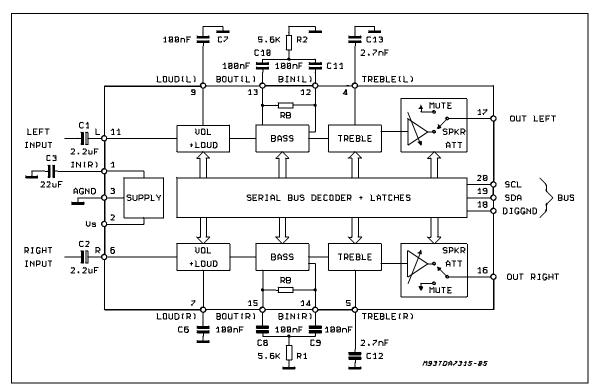
The AC signal setting is obtained by resistor networks



and switches combined with operational amplifiers.

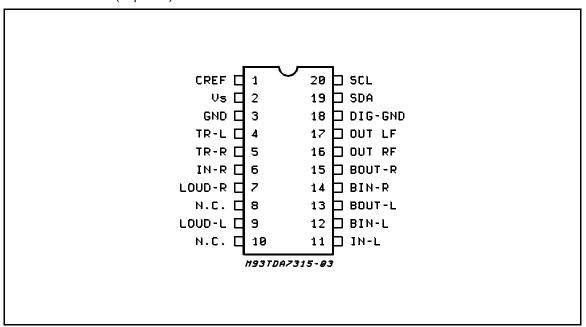
Thanks to the used BIPOLAR/CMOS Technology, Low Distortion, Low Noise and DC stepping are obtained

BLOCK DIAGRAM



July 1998 1/12

PIN CONNECTION (Top view)



THERMAL DATA

Symbol	Parameter	SO 20	DIP 20	Unit	
R _{th j-pins}	Thermal Resistance Junction-pins	Max.	150	150	°C/W

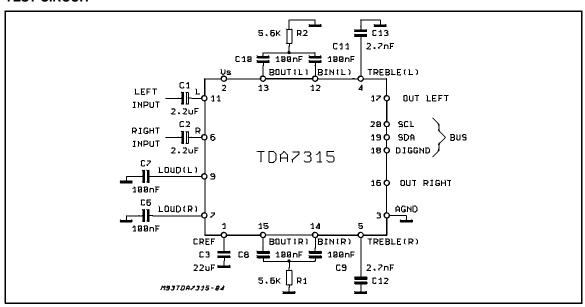
ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
Vs	Operating Supply Voltage	10.2	V
T _{amb}	Operating Ambient Temperature	-10 to 85	ô
T _{stg}	Storage Temperature Range	-55 to +150	°C

QUICK REFERENCE DATA

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vs	Supply Voltage	6	9	10	V
V_{CL}	Max. input signal handling	2			Vrms
THD	Total Harmonic Distortion V = 1Vrms f = 1KHz		0.01	0.1	%
S/N	Signal to Noise Ratio		106		dB
$S_{\mathbb{C}}$	Channel Separation f = 1KHz		103		dB
	Volume Control 1.25dB step	-78.75		0	dB
	Bass and Treble Control 2db step	-14		+14	dB
	Balance Control 1.25dB step	-38.75		0	dB
	Mute Attenuation		100		dB

TEST CIRCUIT



ELECTRICAL CHARACTERISTICS (refer to the test circuit T_{amb} = 25°C, V_S = 9V, R_L = 10K Ω , R_G = 600 Ω , all controls flat (G = 0), f = 1KHz unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
SUPPLY						
Vs	Supply Voltage		6	9	10	V
Is	Supply Current			8	11	mA
SVR	Ripple Rejection		60	80		dB
VOLUME C	ONTROL					
R _{IV}	Input Resistance		20	33	50	kΩ
Crange	Control Range		70	75	80	dB
A _{VMIN}	Min. Attenuation		-1	0	1	dB
A _{VMAX}	Max. Attenuation		70	75	80	dB
A _{STEP}	Step Resolution		0.5	1.25	1.75	dB
E _A	Attenuation Set Error	Av = 0 to -20 dB Av = -20 to -60 dB	-1.25 -3	0	1.25 2	dB dB
E _T	Tracking Error				2	dB
V _{DC}	DC Steps	adjacent attenuation steps From 0dB to Av max		0 0.5	3 7.5	mV mV
SPEAKER A	ATTENUATORS					
C _{range}	Control Range		35	37.5	40	dB
S _{STEP}	Step Resolution		0.5	1.25	1.75	dB
EA	Attenuation set error				1.5	dB
Амите	Output Mute Attenuation		80	100		dB
V _{DC}	DC Steps	adjacent att. steps from 0 to mute		0 1	3 10	mV mV
BASS CON	TROL (1)	·				
Gb	Control Range	Max. Boost/cut	<u>+</u> 12	<u>+</u> 14	<u>+</u> 16	dB
B _{STEP}	Step Resolution		1	2	3	dB
R_B	Internal Feedback Resistance		34	44	58	ΚΩ

ELECTRICAL CHARACTERISTICS (continued)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
TREBLE CO	ONTROL (1)					
Gt	Control Range	<u>+</u> 14	<u>+</u> 15	dB		
T _{STEP}	Step Resolution		1	2	3	dB
AUDIO OU	TPUTS					
V _{OCL}	Clipping Level	d = 0.3%	2	2.5		Vrms
R_{L}	Output Load Resistance		2			KΩ
C_L	Output Load Capacitance				10	nF
Rout	Output resistance		30	75	120	Ω
Vout	DC Voltage Level		4.2	4.5	4.8	V
GENERAL						
e _{NO}	Output Noise	BW = 20-20KHz, flat output muted all gains = 0dB		2.5 5	15	μV uV

		all gains = 00b		5	15	μν
		A curve all gains = 0dB		3		μV
S/N	Signal to Noise Ratio	all gains = 0dB; V _O = 1Vrms		106		dB
d	Distortion	$\begin{aligned} A_V &= 0, V_{IN} = 1 Vrms \\ A_V &= -20 dB V_{IN} = 1 Vrms \\ V_{IN} &= 0.3 Vrms \end{aligned}$		0.01 0.09 0.04	0.1 0.3	% % %
Sc	Channel Separation left/right		80	103		dB
	Total Tracking error	A _V = 0 to -20dB -20 to -60 dB		0	1 2	dB dB

BUS INPUTS

V_{IL}	Input Low Voltage			1	V
V _{IH}	Input High Voltage		3		V
I _{IN}	Input Current		-5	+5	μΑ
Vo	Output Voltage SDA Acknowledge	I _O = 1.6mA		0.4	V

Note:

Figure 1: Loudness versus Volume Attenuation

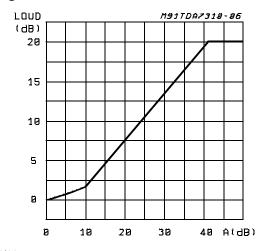
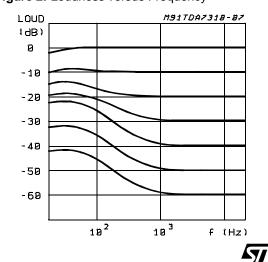
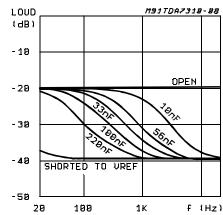


Figure 2: Loudness versus Frequency



⁽¹⁾ Bass and Treble response see attached diagram (fig.19). The center frequency and quality of the resonance behaviour can be choosen by the external circuitry. A standard first order bass response can be realized by a standard feedback network.

Figure 3: Loudness versus External Capacitors



LOUDNESS $V_S = 9V$ $V_S = -40dB$ All other control flat $C_{in} = 2.2\mu F$

C_{loud} = 220nF, 100nF, 33nF, 10nF, Open, Shorter to Vref

Figure 5: Signal to Noise Ratio vs. Volume Setting

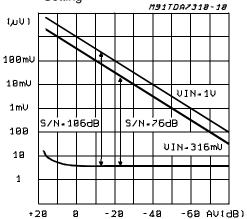


Figure 7: Distortion & Noise vs. Frequency

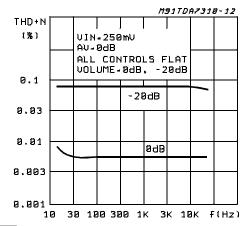


Figure 4: Noise vs. Volume/Gain Settings

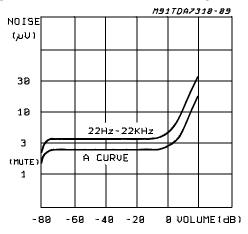


Figure 6: Distortion & Noise vs. Frequency

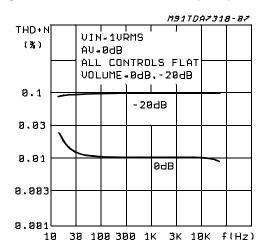


Figure 8: Distortion vs. Load Resistance

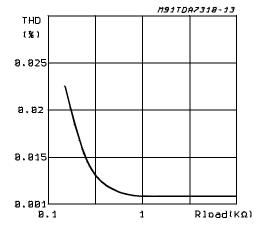


Figure 9: Channel Separation $(L \rightarrow R)$ vs. Frequency

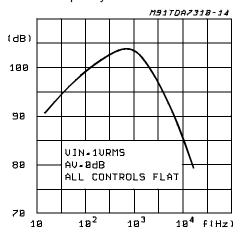


Figure 11: Output Clipping Level vs. Supply Voltage

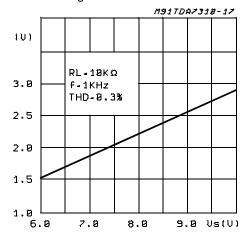


Figure 13: Supply Current vs. Temperature

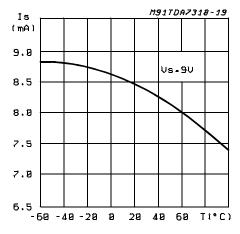


Figure 10: Supply Voltage Rejection vs. Frequency

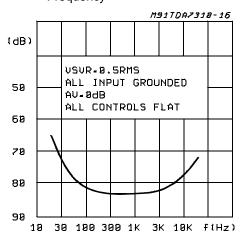


Figure 12: Quiescent Current vs. Supply Voltage

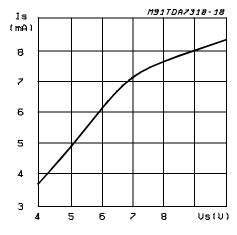


Figure 14: Bass Resistance vs. Temperature

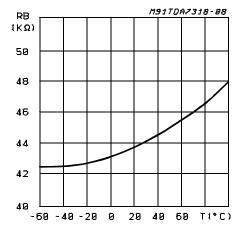
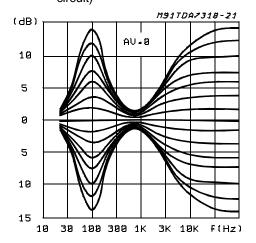


Figure 15: Typical Tone Response (with the ext. components indicated in the test circuit)



SOFTWARE SPECIFICATION

Interface Protocol

The interface protocol comprises:

- A start condition (S)
- A chip address byte, containing the TDA7315 address (the 8th bit of the byte must be 0). The TDA7315 must always acknowledge at the end of each transmitted byte.
- A sequence of data (N-bytes + acknowledge)
- A stop condition (P)



ACK = Acknowledge

S = Start

P = Stop

MAX CLOCK SPEED 100kbits/s

SOFTWARE SPECIFICATION

Chip address = 80 Hex

-								
	1	0	0	0	0	0	0	0
	MSB							LSB

DATA BYTES

MSB							LSB	FUNCTION
0	0	B2	B1	В0	A2	A1	A0	Volume control
1	0	0	B1	B0	A2	A1	A0	Speaker ATT L
1	0	1	B1	В0	A2	A1	A0	Speaker ATT R
0	1	0	X	Χ	L	X	X	Loudness
0	1	1	0	C3	C2	C1	C0	Bass control
0	1	1	1	C3	C2	C1	C0	Treble control

Ax = 1.25dB steps; Bx = 10dB steps; Cx = 2dB steps; X = don't care.



SOFTWARE SPECIFICATION (continued)

DATA BYTES (detailed description)

Volume

MSB							LSB	FUNCTION
0	0	B2	B1	В0	A2	A1	A0	Volume 1.25dB steps
					0	0	0	0
					0	0	1	-1.25
					0	1	0	-2.5
					0	1	1	-3.75
					1	0	0	-5
					1	0	1	-6.25
					1	1	0	-7.5
					1	1	1	-8.75
0	0	B2	B1	В0	A2	A1	A0	Volume 10dB steps
		0	0	0				0
		0	0	1				-10
		0	1	0				-20
		0	1	1				-30
		1	0	0				-40
		1	0	1				-50
		1	1	0				-60
		1	1	1				-70

For example a volume of -45dB is given by:

 $0 \ 0 \ 1 \ 0 \ 0 \ 1 \ 0 \ 0$

Speaker Attenuators

MSB							LSB	FUNCTION
1 1	0 0	0 1	B1 B1	B0 B0	A2 A2	A1 A1	A0 A0	Speaker L Speaker R
					0 0 0 0 1 1 1	0 0 1 1 0 0	0 1 0 1 0 1 0	0 -1.25 -2.5 -3.75 -5 -6.25 -7.5 -8.75
			0 0 1 1	0 1 0 1				0 -10 -20 -30
			1	1	1	1	1	Mute

For example attenuation of 25dB on speaker R is given by:

10110100

Loudness

MSB							LSB	FUNCTION
0	1	0	Χ	Χ	L	Х	Χ	
					0			LOUDNESS ON
					1			LOUDNESS OFF

x = don't care For examples Loudness Off can be programmed by the following 8 bit string:

0 1 0 0 0 1 0 0

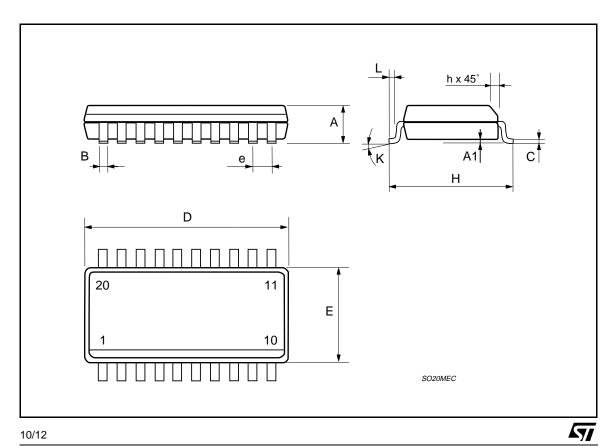
Bass and Treble

0	1 1	1 1	0 1	C3 C3	C2 C2	C1 C1	C0 C0	Bass Treble
				0	0	0	0	-14
				0	0	0	1	-12
				0	0	1	0	-10
				0	0	1	1	-8
				0	1	0	0	-6
				0	1	0	1	-4
				0	1	1	0	-2
				0	1	1	1	0
				1	1	1	1	0
				1	1	1	0	2
				1	1	0	1	4
				1	1	0	0	6
				1	0	1	1	8
				1	0	1	0	10
				1	0	0	1	12
				1	0	0	0	14

C3 = Sign
For example Bass at -10dB is obtained by the following 8 bit string:
0 1 1 0 0 0 1 0

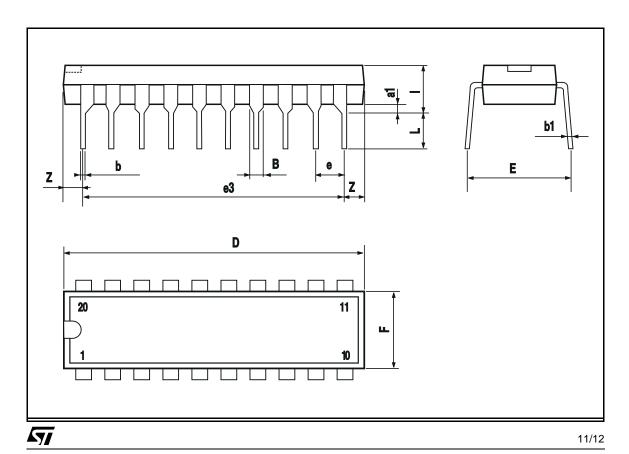
SO20 PACKAGE MECHANICAL DATA

DIM.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	2.35		2.65	0.093		0.104	
A1	0.1		0.3	0.004		0.012	
В	0.33		0.51	0.013		0.020	
С	0.23		0.32	0.009		0.013	
D	12.6		13	0.496		0.512	
Е	7.4		7.6	0.291		0.299	
е		1.27			0.050		
Н	10		10.65	0.394		0.419	
h	0.25		0.75	0.010		0.030	
L	0.4		1.27	0.016		0.050	
К	0 (min.)8 (max.)						



DIP20 PACKAGE MECHANICAL DATA

DIM.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
a1	0.254			0.010			
В	1.39		1.65	0.055		0.065	
b		0.45			0.018		
b1		0.25			0.010		
D			25.4			1.000	
E		8.5			0.335		
е		2.54			0.100		
e3		22.86			0.900		
F			7.1			0.280	
1			3.93			0.155	
L		3.3			0.130		
Z			1.34			0.053	



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